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FDMC8327L

N-Channel PowerTrench[®] MOSFET 40 V, 14 A, 9.7 m Ω

Features

- \blacksquare Max $r_{DS(on)}$ = 9.7 m Ω at V_{GS} = 10 V, I_{D} = 12 A
- Max $r_{DS(on)}$ = 12.5 m Ω at V_{GS} = 4.5 V, I_D = 10 A
- Low Profile 0.8mm max in Power 33
- 100% UIL test
- RoHS Compliant

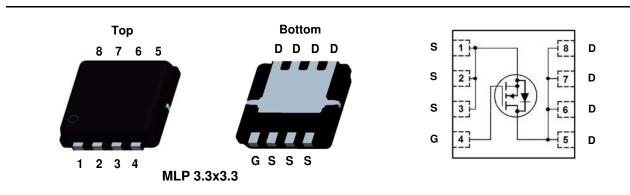


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench[®] process that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance.

Application

DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			40	V	
V _{GS}	Gate to Source Voltage			±20	V	
ID	Drain Current - Continuous (Package limited)	T _C = 25 °C		14		
	- Continuous (Silicon limited) $T_{C} = 25 \text{ °C}$		43	А		
	- Continuous	T _A = 25 °C	(Note 1a)	12		
	- Pulsed			60		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	25	mJ	
P _D	Power Dissipation	T _C = 25 °C		30	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.3	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C		
Thermal Ch	naracteristics					
R _{θJC}	Thermal Resistance, Junction to Case		(Note 1)	4.2	°C/W	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient		(Note 1a)	53		

Package Marking and Ordering Information

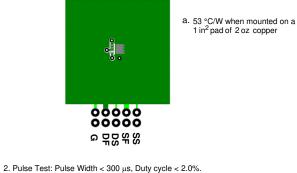
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC8327L	FDMC8327L	Power 33	13 "	12 mm	3000 units

October 2013

Symbol	Parameter	Test Con	ditions	Min	Тур	Max	Units	
	cteristics	1			,,			
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V		40			V	
ΔBV_{DSS} ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C			22		mV/°C	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 32 V, V_{GS} = 0 V$				1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$	/			±100	nA	
On Chara	cteristics							
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$		1.0	1.7	3.0	V	
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, referenced	l to 25 °C		-5		mV/°C	
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12 \text{ A}$	7.		7.4	9.7	mΩ	
		$V_{GS} = 4.5 \text{ V}, \ I_D = 10 \text{ A}$			9.4	12.5		
		$V_{GS} = 10 \text{ V}, \ I_D = 12 \text{ A},$	T _J = 125 °C		11	14.5		
9fs	Forward Transconductance	$V_{DD} = 5 V, I_D = 12 A$			52		S	
Dynamic	Characteristics							
C _{iss}	Input Capacitance	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHZ			1235	1850	pF	
C _{oss}	Output Capacitance				347	520	pF	
C _{rss}	Reverse Transfer Capacitance				21	35	pF	
R _g	Gate Resistance			0.1	0.6	1.3	Ω	
Switching	Characteristics							
t _{d(on)}	Turn-On Delay Time				8.4	17	ns	
t _r	Rise Time	V_{DD} = 20 V, I _D = 12 A, V _{GS} = 10 V, R _{GEN} = 6 Ω			2.2	10	ns	
t _{d(off)}	Turn-Off Delay Time				20	32	ns	
t _f	Fall Time				2.2	10	ns	
Q _{g(TOT)}	Total Gate Charge	V _{GS} = 0V to 10 V			18.5	26	nC	
Q _{q(TOT)}	Total Gate Charge	$V_{GS} = 0V$ to 5 V	$V_{DD} = 20 V,$		9.7	14	nC	
Q _{gs}	Gate to Source Charge		I _D = 12 A		3.3		nC	
Q _{gd}	Gate to Drain "Miller" Charge				2.6		nC	
Drain-Sou	urce Diode Characteristics					•		
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 1.8 A	(Note 2)		0.7	1.2	.2	
		$V_{GS} = 0 V, I_S = 12 A$	(Note 2)		0.8	1.3	V	
t _{rr}	Reverse Recovery Time	$I_{\rm F} = 12$ A, di/dt = 100 A/s			32	51	ns	
						1		

Notes:

1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



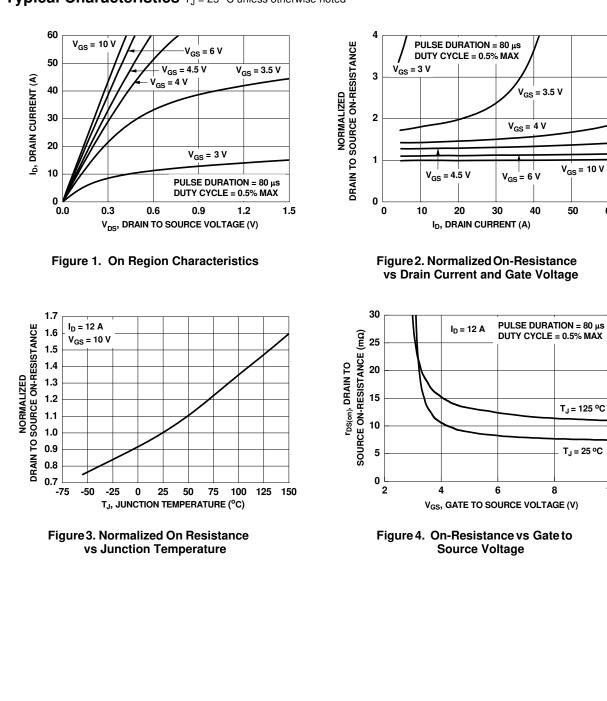
3. Starting T_J = 25 °C; N-ch: L = 0.3 mH, I_{AS} = 13 A, V_{DD} = 36 V, V_{GS} = 10 V.



b. 125 °C/W when mounted on a minimum pad of 2 oz copper

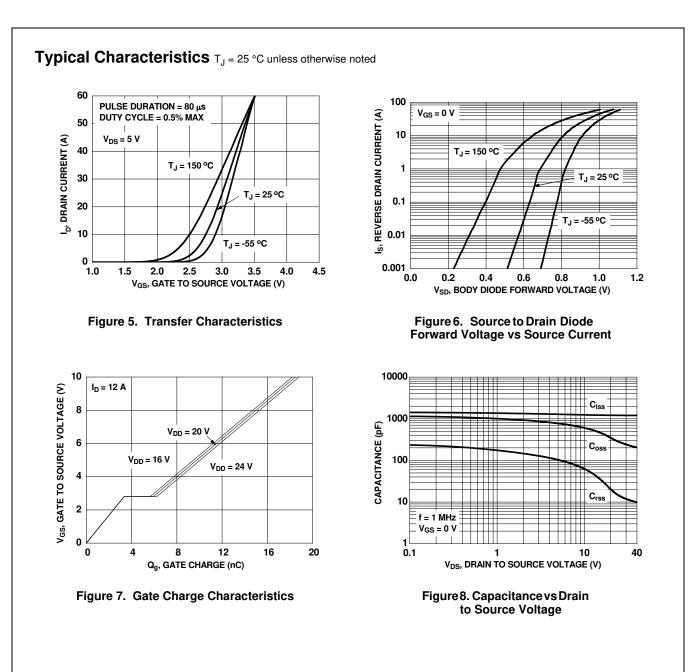
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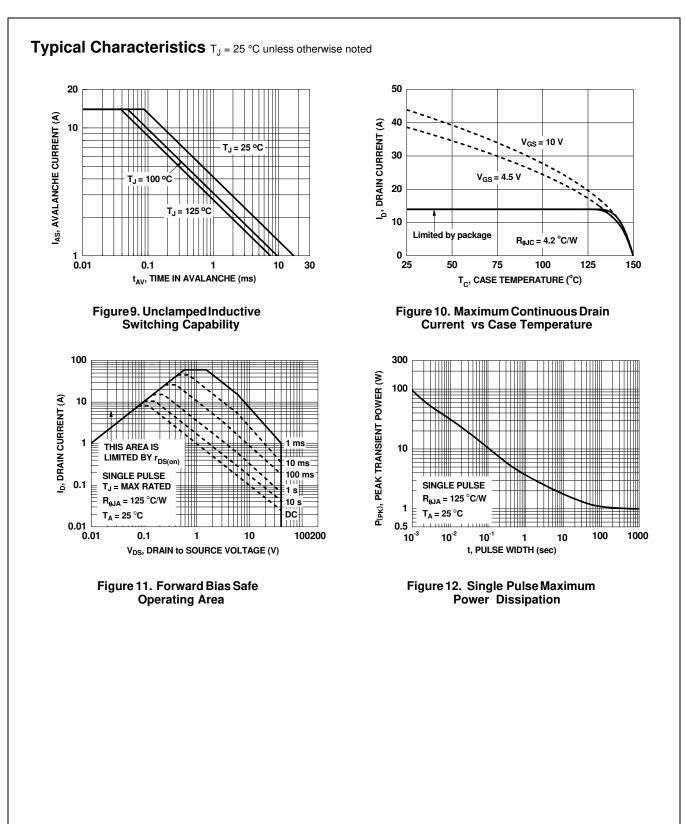


Typical Characteristics T_J = 25 °C unless otherwise noted

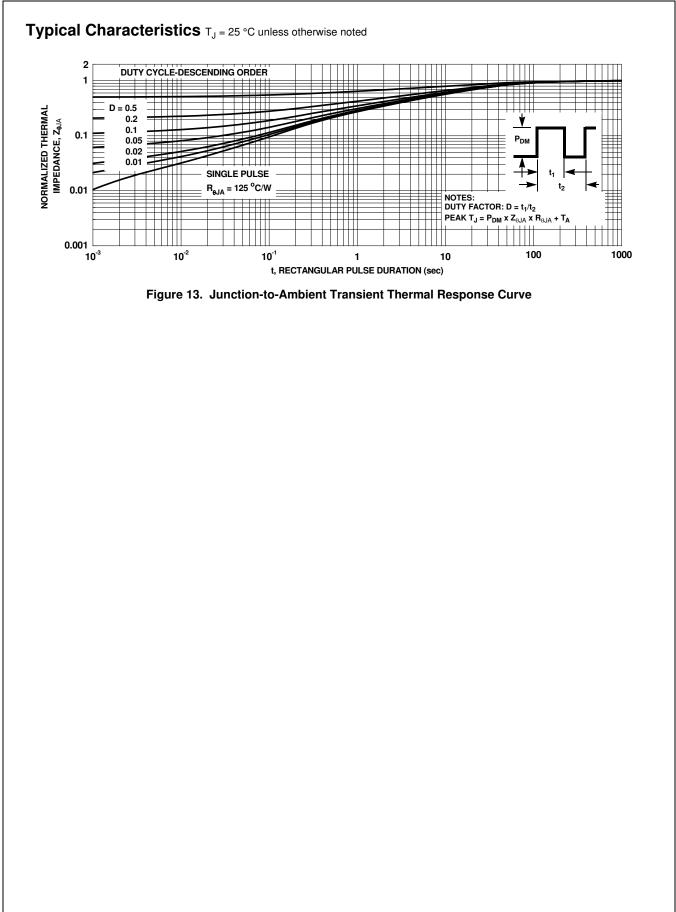
FDMC8327L N-Channel PowerTrench[®] MOSFET

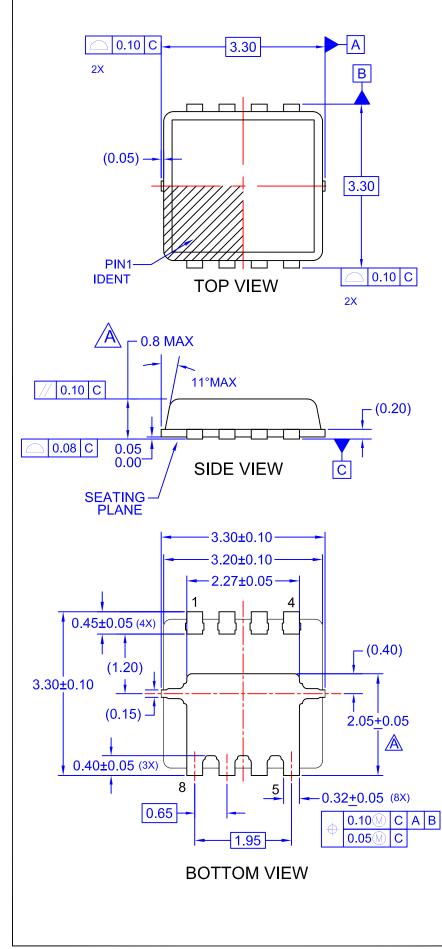


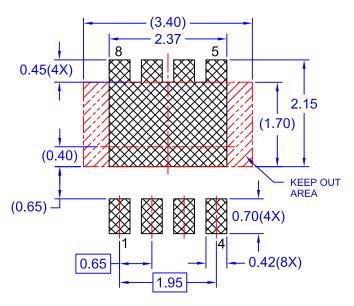
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RECOMMENDED LAND PATTERN

NOTES:

- A EXCEPT AS NOTED, PACKAGE CONFORMS TO JEDEC REGISTRATION MO-240 VARIATION BA.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- D. SEATING PLANE IS DEFINED BY TERMINAL TIPS ONLY
- E. BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH PROTRUSIONS NOR GATE BURRS.
- F. FLANGE DIMENSIONS INCLUDE INTERTERMINAL FLASH OR PROTRUSION. INTERTERMINAL FLASH OR PROTRUSION SHALL NOT EXCEED 0.25MM PER SIDE.
- G. IT IS RECOMMENDED TO HAVE NO TRACES OR VIA WITHIN THE KEEP OUT AREA.
- H. DRAWING FILENAME: MKT-MLP08Trev4.
- I. GENERAL RADII FOR ALL CORNERS SHALL BE 0.20MM MAX.



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